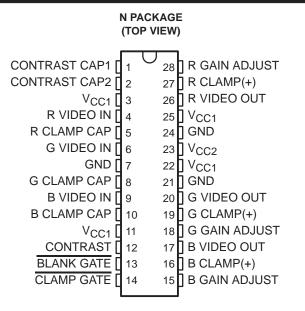
- Wide Bandwidth . . . Typ 100 MHz at −3 dB
- 0-V to 4-V Digital Level-Contrast Control Voltage Range
- 0-V to 4-V Digital Level-Gain Adjust Control Voltage Range
- Individual Gain Adjust for Video Amplifiers
- Output-Stage Blanking
- Fewer Peripheral Components Required Than for Competitive Systems

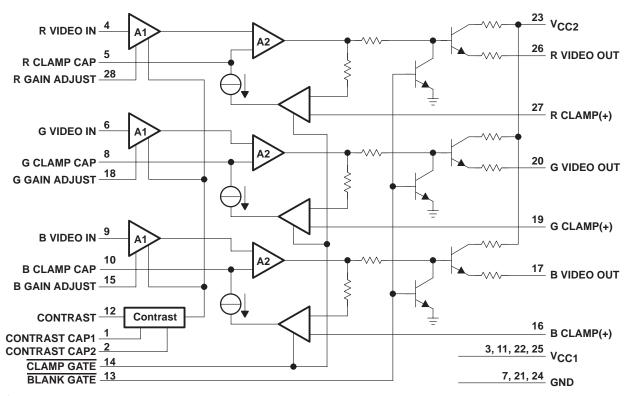
### description

The TLS1215 is a wide-band video preamplifier system intended for high-resolution RGB (red-green-blue) color monitors with blanking control features. Each video amplifier (R, G, and B) contains a gain set for adjusting maximum system gain. The TLS1215 provides digital



level-operated contrast, brightness, and gain adjustment. All the control inputs offer high input impedance and an operation range from 0 V to 4 V for easy interface to the serial digital buses. The TLS1215 also contains a blanking circuit, which clamps the video output voltage during blanking period to as low as 0.2 V above ground. The device operates from a 12-V supply. The TLS1215 is characterized for operation from 0°C to 70°C.

### functional block diagram





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



### TLS1215 WIDE-BAND VIDEO PREAMPLIFIER SYSTEM WITH BLANKING

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	13.5 V
Input voltage range, V <sub>I</sub> (see Note 1)	
Video output current (per channel)	28 mA
Total power dissipation at (or below) 25°C free-air temperature (see Note 2)	2.1 W
Operating virtual junction temperature, T <sub>J</sub>	150°C
Operating free-air temperature range, T <sub>A</sub>	
Storage temperature range, T <sub>stq</sub>	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All VCC pins must be externally wired together to prevent internal damage during VCC power-on/off cycles.
  - 2. For operation above 25°C free-air temperature, derate linearly to 1.5 W at the rate of 13 mW/°C.

### recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC1</sub> and V <sub>CC2</sub>			12	13.2	V
High-level input voltage, CLAMP GATE, VIH	Clamp comparators off	2.4		5	V
Low-level input voltage, CLAMP GATE, V <sub>IL</sub>	Clamp comparators on	0		0.8	V
High-level input voltage, BLANK GATE, VIH	Blanking circuit inactive	2.4		5	V
Low-level input voltage, BLANK GATE, V <sub>IL</sub>	Blanking circuit active	0		0.8	V
Operating free-air temperature, T <sub>A</sub>				70	°C

# electrical characteristics at 25°C operating free-air temperature range, $\overline{\text{CLAMP GATE}} = 0 \text{ V}$ , $\overline{\text{BLANK GATE}} = 4 \text{ V}$ , $\overline{\text{CLAMP(+)}} = 2 \text{ V}$ , $\overline{\text{CONTRAST}} = R$ , G, B GAIN ADJUST = 4 V, $\overline{\text{VCC1}} = \overline{\text{VCC2}} = 12 \text{ V}$ (see Figure 2) (unless otherwise noted)

	PARAMETER	ALT SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ICC	Supply current		V <sub>CC1</sub> + V <sub>CC2</sub>	78	90	100	mA
V <sub>ref</sub>	Video input reference voltage		Measure R, G, B VIDEO IN	2.1	2.3	2.6	V
Ц	Contrast, R, G, B gain adjust input current	Ц	Measure CONTRAST and B, G, R GAIN ADJUST		-1	-2.5	μΑ
IIL	Clamp gate low input current		CLAMP GATE = 0 V		-1	-2.5	μΑ
ΙΗ	Clamp gate high input current		CLAMP GATE = 5 V		0.03	1	μΑ
	Clamp capacitor charge current	I <sub>K(chg)</sub>	R, G, B CLAMP CAP = 0 V		-850		μΑ
	Clamp capacitor discharge current	I <sub>K(dschg)</sub>	R, G, B CLAMP CAP = 5 V		+850		μΑ
V <sub>OL</sub>	Low-level output voltage		R, G, B CLAMP CAP = 0 V		0.3		V
VOH	High-level output voltage		R, G, B CLAMP CAP = 5 V		7.8		V
VO(blanked)	Blanked output voltage		Blanking circuit active		0.2		V
VO(diff)	Output voltage difference	VOdiff	Between any two channels		±0.5	±50	mV

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## operating characteristics at 25°C free-air temperature range, $\overline{\text{CLAMP GATE}}$ = 0 V, $\overline{\text{BLANK GATE}}$ = 4 V, $\overline{\text{CLAMP}}$ (+) = 4 V, $\overline{\text{CONTRAST}}$ = R, G, B GAIN ADJUST = 4 V, $\overline{\text{f}}_{\text{I}}$ = 10 kHz (unless otherwise noted)

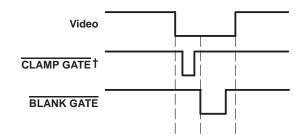
	PARAMETER	ALT SYMBOL	TEST CONDITIONS	MIN TYP N	ИАХ	UNIT
A <sub>V(max)</sub>	Maximum voltage amplification	A <sub>VMAX</sub>	CONTRAST = 4 V, V <sub>I</sub> (PP) = 700 mV	7.8		V/V
AV(mid)	Mid-range voltage amplification	A <sub>VMID</sub>	CONTRAST = 2 V, VI(PP) = 700 mV	2		V/V
	Contrast voltage for mini- mum amplification	VCONTRASTLOW	V <sub>I(PP)</sub> = 1 V, See Note 3	1		V
	Amplification match at AV(max)	A <sub>VMAX</sub> (DIFF)	CONTRAST = 4 V, See Note 4	±0.2		dB
	Amplification match at AV(mid)	A <sub>V</sub> MID(DIFF)	CONTRAST = 2 V, See Note 3	±0.2		dB
	Amplification match at Av(low)	AVLOW(DIFF)	CONTRAST = VCONTRASTLOW, See Notes 3 and 4	±0.2		dB
THD	Total harmonic distortion	THD	CONTRAST = 1 V, V <sub>I(PP)</sub> = 1 V	1.0%		
BW	Amplifier bandwidth	BW(-3 dB)	CONTRAST = 4 V, See Notes 5 and 7	100		MHz
	Crosstalk attenuation		CONTRAST = 4 V, f = 10 kHz, See Note 6	80		dB
Crosstalk attenuati	Crosstalk attenuation	a <sub>X</sub>	CONTRAST = 4 V, f = 10 MHz, See Notes 6 or 7	40		dB
	Pulse test	Tr, video Tf, video	V <sub>O(PP)</sub> = 4 V, CONTRAST = 4 V, Clamp(+) = 2 V, See Notes 5 and 7	4		
	ruise test	Tr, blank Tf, blank	CONTRAST = 4 V , Clamp(+) = 2 V, See Notes 5 and 7	7		ns

NOTES: 3. Determine  $V_{\mbox{CONTRASTLOW}}$  for  $-40~\mbox{dB}$  attenuation of output. Reference to  $A_{\mbox{V}}$  maximum.

- 4. Measure gain difference between any two amplifiers,  $V_{I(PP)} = 1 \text{ V}$ .
- 5. Adjust input frequency from 10 kHz (A<sub>V</sub> maximum ref level) to the -3 dB corner frequency (f-3 dB).  $V_{\parallel}(PP) = 700$  mV.
- 6. V<sub>I</sub>(pp) = 700 mV at f = 10 kHz to any amplifier. Measure output levels of the other two undriven amplifiers relative to driven amplifier.
- 7. A special text fixture without a socket and a double-sided full-ground-plane PC board are required.

#### APPLICATION INFORMATION CONTRAST 28 **R GAIN ADJUST** CAP 1 **0.1** μ**F** 2 CONTRAST R CLAMP(+) CAP 2 **0.1** μ**F** To Red Cascode Driver 3 26 V<sub>CC1</sub> **R VIDEO OUT** 390 $\Omega$ **0.1** μ**F** Red Video In 4 R VIDEO IN V<sub>CC1</sub> **75** Ω ≥ **0.1** μF 5 **10** μ**F** R CLAMP CAP **GND 0.1** μ**F 0.1** μF Green Video In 6 G VIDEO IN V<sub>CC2</sub> **0.1** μF **75** $\Omega$ 7 10 $\mu$ F GND V<sub>CC1</sub> **0.1** μ**F** 8 G CLAMP CAP **GND 0.1** μF Blue Video In To Green Cascode Drive 9 20 **G VIDEO OUT B VIDEO IN 75** Ω ≷ $\mathbf{390}~\Omega$ 10 19 **10** μ**F B CLAMP CAP** G CLAMP(+) $\textbf{0.1}~\mu\textbf{F}$ **0.1** μF 11 18 **G GAIN ADJUST** V<sub>CC1</sub> $\textbf{0.1}~\mu \textbf{F}$ 4 V To Blue Cascode Driver 12 17 CONTRAST **B VIDEO OUT** 390 $\Omega$ $0.1 \mu F$ 13 16 **BLANK GATE BLANK GATE** B CLAMP(+) **0.1** μ**F** 14 15 **CLAMP GATE** CLAMP GATE **B GAIN ADJUST 0.1** μ**F** 12 V

Figure 1. Test/Application Circuit



† Minimum CLAMP GATE pulse: 300 ns

Figure 2. Test/Application Circuit Timing Diagram





### PACKAGE OPTION ADDENDUM

30-Mar-2005

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLS1215N	OBSOLETE	PDIP	N	28	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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